

On-Wafer, Non-contact Characterization of Differential-mode mmW and THz Devices and Integrated Circuits

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Differential circuit topologies offer key advantages such as improved noise performance, gain, stability and bandwidth. Although commonly used in analog RF and millimeter-wave (mmW) applications, differential terahertz monolithically integrated circuits (TMICs) are emerging to harness the aforementioned advantages for high performance applications (Öjefors et. al, *IEEE Transactions on Microwave Theory and Techniques*, vol. 60, no. 5, pp. 1397-1404, 2012). Nevertheless, on-wafer testing of differential devices and circuits for mmW and sub-mmW applications has long been a challenge due to the fragility of contact-based probes and the requirement for on-chip baluns. Although there are efforts for balun-integrated contact probe tips (Zhang et. al, 2014 *IEEE International Microwave Symposium*), scaling of current prototypes at W-band to sub-mmW range is extremely challenging.

As an alternative to conventional contact-probe testing, we recently proposed a non-contact on-wafer device characterization approach that is both low-cost and wear/tear free (Caglayan et. al, *IEEE Transactions on Microwave Theory and Techniques*, vol. 62, no. 11, pp. 2791-2801, 2014). This non-contact method is based on radiative coupling of standard network analyzer test ports onto the wafer environment of typical monolithic THz devices enabled by planar on-chip antennas integrated with the device. Here, we present –for the first time- new on-chip antenna designs allowing straightforward characterization of differential mmW and THz electronics without the need of an integrated or on-wafer balun structure. With the new differential antenna designs, non-contact GSGSG probing is possible while concurrently suppressing the common mode, thanks to the unique radiation properties of the on-wafer antennas. The common-mode pattern of the new antenna exhibits a null in the broadside direction, thus, any common-mode return signal is radiated away from the test-port leading to excellent isolation of the common and differential modes. Experimental performance of the new differential-mode non-contact probes will be presented at the conference.